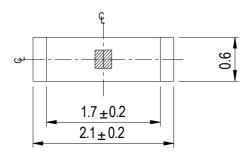
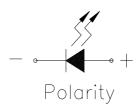
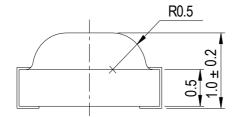


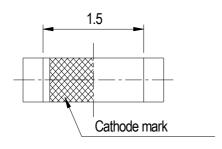
#### **Package Outline Dimensions**

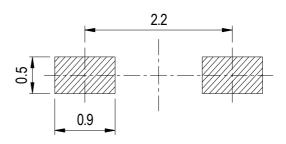






For reflow soldering (Propose)





**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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#### **Absolute Maximum Ratings (Ta=25℃)**

Parameter	Symbol	Rating	Unit		
Reverse Voltage	$V_R$	5	V		
Forward Current	IF	25	mA		
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	60	mA		
Power Dissipation	Pd	60	mW		
Electrostatic Discharge(HBM)	ESD	2000	V		
Operating Temperature	Topr	-40 ~ +85	${\mathbb C}$		
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.			

# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition	
		A2	16.0	39				
		A3	36.0	57				
Luminous Intensity	Iv	A4	52.0	78		mcd		
		A5	62.0	98		ı		
		A6	78.0	114				
Viewing Angle	201/2			130		deg	I <sub>F</sub> =20mA	
Peak Wavelength	λр			591		nm		
Dominant Wavelength	λd			589		nm		
Spectrum Radiation Bandwidth	Δλ			15		nm		
Forward Voltage	$V_{\mathrm{F}}$		1.7	2.0	2.4	V		
Reverse Current	$I_R$				10	μΑ	V <sub>R</sub> =5V	

# \*12-215UYC/S530-XX/TR8

Chip Rank

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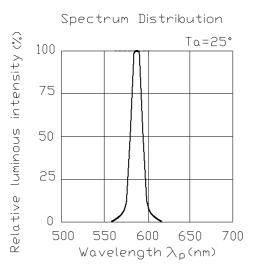
Prepared date:19-Aug-2005

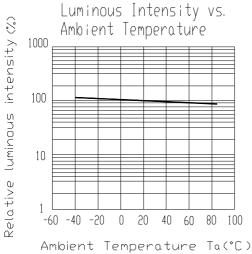


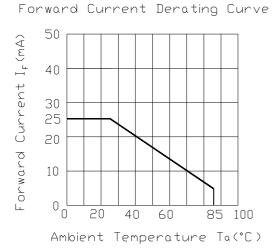
# EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

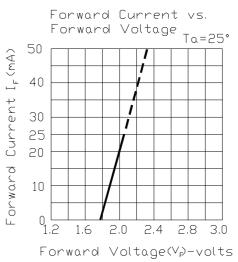
#### 12-215UYC/S530-XX/TR8

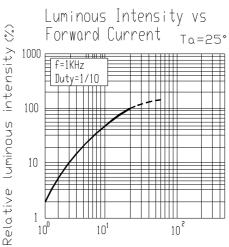
#### Electro-Optical Characteristics (Ta=25°C)

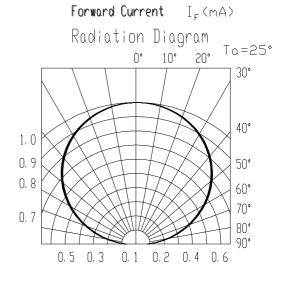












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#### Label explanation

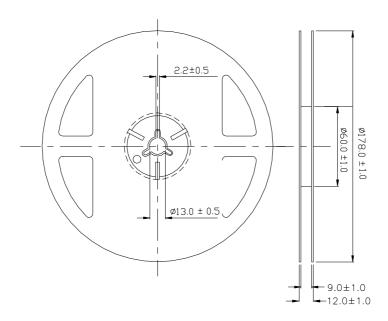
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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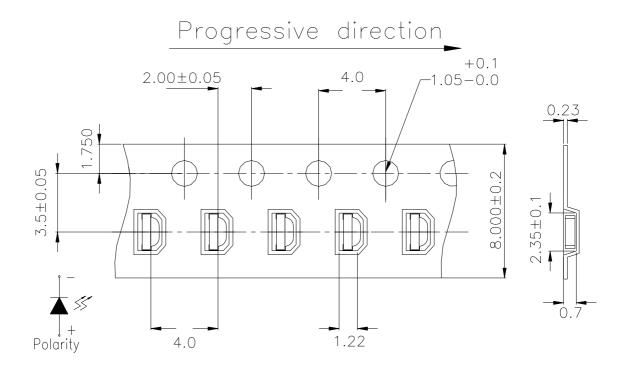
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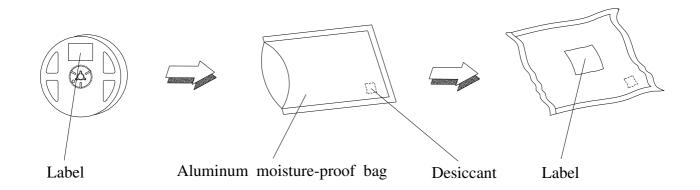


## Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

#### **Moisture Resistant Packaging**



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## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	10 sec 300 Cycles		0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 PCS.	0/1

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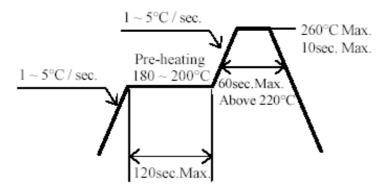
#### 12-215UYC/S530-XX/TR8

#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30 °C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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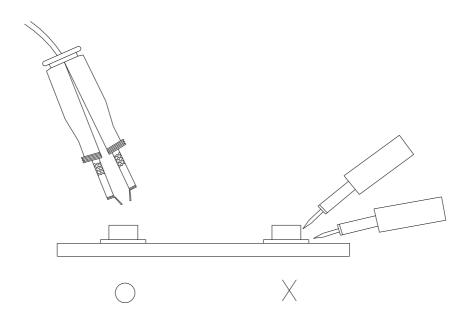


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

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